IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

plication of:

Chad A. Cobbley et al.

Group Art Unit:

2813

Serial No.: 10/770,919

Examiner:

Blum, David S.

Filed:

February 3, 2004

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For:

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TECHNIQUES FOR FORMING A

STACKED DIE MODULE

Atty Docket: MICS:0078-5/FLE

(01-0752.05)

Mail Stop Amendment Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450 CERTIFICATE OF MAILING 37 C.F.R. 1.8

I hereby certify that this correspondence is being deposited with the U.S. Postal Service with sufficient postage as First Class Mail in an envelope addressed to: Mail Stop Amendment, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on the dat

May 22, 2006

Date

Sir:

RESPONSE TO OFFICE ACTION MAILED FEBRUARY 22, 2006

In response to the Office Action mailed February 22, 2006, Applicants respectfully request reconsideration of the above-identified application in view of the amendments and remarks set forth below.